

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4885086

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MOTOHITO HORI	01/15/2018
YUKI INABA	01/19/2018
YOSHINARI IKEDA	01/15/2018
TETSUYA SUNAGO	02/15/2018
MICHIHIRO INABA	02/15/2018

RECEIVING PARTY DATA

Name:	FUJI ELECTRIC CO., LTD.
Street Address:	1-1 TANABESHINDEN, KAWASAKI-KU
City:	KAWASAKI-SHI, KANAGAWA
State/Country:	JAPAN
Postal Code:	210-9530
Name:	KOJIN CO., LTD.
Street Address:	5 MORIJIRI, KAMIICHI-MACHI
City:	NAKANIIKAWA-GUN, TOYAMA
State/Country:	JAPAN
Postal Code:	930-0304

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15934256

CORRESPONDENCE DATA

Fax Number: (202)434-1501

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 202-434-1500

Email: DPelkey@s-n-h.com

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Address Line 1: 1201 NEW YORK AVE NW

Address Line 2: 7TH FLOOR

Address Line 4: WASHINGTON, D.C. 20176

ATTORNEY DOCKET NUMBER:	2482.1048
NAME OF SUBMITTER:	DAVID M. PITCHER REG NO. 25,908
SIGNATURE:	/David M. Pitcher/
DATE SIGNED:	03/27/2018
Total Attachments: 3 source=Assignment_as_filed#page1.tif source=Assignment_as_filed#page2.tif source=Assignment_as_filed#page3.tif	

U.S. ASSIGNMENT

Docket No.

NAH 1316

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by

(Insert Name(s) & Address(es) of ASSIGNEE(S))

FUJI ELECTRIC CO., LTD.

1-1, Tanabeshinden, Kawasaki-ku, Kawasaki-shi, Kanagawa 210-9530 JAPAN

KOJIN Co., Ltd.

5 Morijiri, Kamiichi-machi, Nakaniikawa-gun, Toyama 930-0304 Japan

(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled
(Title of Invention)

SEMICONDUCTOR DEVICE, METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE, AND INTERFACE UNIT

relating to International Patent Application and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on _____

(Insert date of execution of application, if not concurrent)

(b) filed on _____

Serial No.: _____

Any registered attorney of STAAS & HALSEY LLP, 1201 New York Avenue, N.W., Suite 700 Washington, D.C. 20005 (202/434-1500) is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).
(Typed Name & Signature of Inventor(s)) (Date)

1) Motohito Hori January 15 2018
(Motohito HORI)

2) _____
(Yuki INABA)

3) Yoshinari Ikeda January 15 2018
(Yoshinari IKEDA)

4) _____
(Tetsuya SUNAGO)

5) _____
(Michihiro INABA)

U.S. ASSIGNMENT

Docket No.

6801130

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by

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(Typed Name & Signature of Inventor(s))

(Date)

1) _____
(Motonito HORI)

2) Yuki Inaba Jan. 19, 2018
(Yuki INABA)

3) _____
(Yoshinari IKEDA)

4) _____
(Tetsuya SUNAGO)

5) _____
(Michihiro INABA)

PATENT

REEL: 045359 FRAME: 0954

U.S. ASSIGNMENT

Docket No.

S&H 1.00

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1) _____
(Motohito HORI)

2) _____
(Yuki INABA)

3) _____
(Yoshinari IKEDA)

4) 石野 哲也 Feb. 15, 2018
(Tetsuya SUNAGO)

5) 稲垣 通弘 Feb. 15, 2018
(Michihiro INABA)